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Octal Buffer/Line Driver with 3-State Output

RENESAS

ADE-205-381 (Z) 1st. Edition Sep. 2000

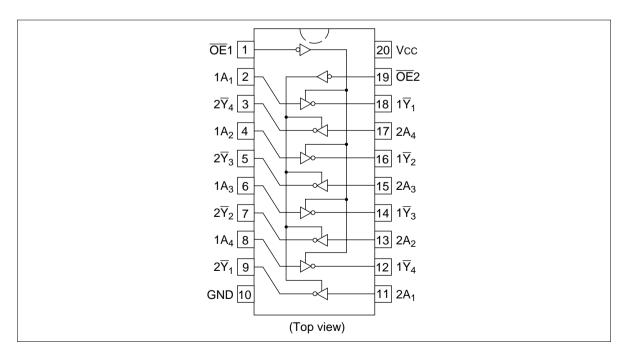
Description

The HD74AC240/HD74ACT240 is an octal buffer and line driver designed to be employed as a memory address driver, clock driver and bus oriented transmitter or receiver which provides improved PC board density.

Features

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- Outputs Source/Sink 24 mA
- HD74ACT240 has TTL-Compatible Inputs

Pin Arrangement



Truth Tables

Inputs		Outputs (Pins 12, 14, 16, 18)
	Α	Y
L	L	Н
L	Н	L
Н	Х	Z
Inputs		Outputs (Pins 3, 5, 7, 9)
	Α	Y
UE2 L	A L	Y H
L L	A L H	•
L L H H	L	•
L L H H : High Voltage Level	L H X	H L
L L H	L H X	H L

Z : High Impedance

DC Characteristics (unless otherwise specified)

Item	Symbol	Max	Unit	Condition
Maximum quiescent supply current	I _{cc}	80	μΑ	$V_{IN} = V_{CC}$ or ground, $V_{CC} = 5.5 V$, Ta = Worst case
Maximum quiescent supply current	I _{cc}	8.0	μΑ	$V_{IN} = V_{CC}$ or ground, $V_{CC} = 5.5$ V, Ta = 25°C
Maximum additional I _{cc} /input (HD74ACT240)	I _{CCT}	1.5	mA	$V_{IN} = V_{CC} - 2.1 \text{ V}, V_{CC} = 5.5 \text{ V},$ Ta = Worst case

+85°C

10.5

9.5

11.5

9.5

1.0

1.0

1.0

1.0

10.0

9.0

10.5

9.0

Unit

ns

ns

ns

ns

ns

ns

AC Characteristics: HD/4AC240								
			Ta = + C _∟ = 5			Ta = –40°C to +8 C _∟ = 50 pF		
Item	Symbol	V _{cc} (V)* ¹	Min	Тур	Max	Min	Max	
Propagation delay	t _{PLH}	3.3	1.0	6.0	8.0	1.0	9.0	
Data to output		5.0	1.0	4.5	6.5	1.0	7.0	
Propagation delay	t _{PHL}	3.3	1.0	5.0	8.0	1.0	8.5	
Data to output		5.0	1.0	4.5	6.0	1.0	6.5	
Output enable time	t _{zH}	3.3	1.0	6.0	10.5	1.0	11.0	
		5.0	1.0	5.0	7.0	1.0	8.0	
Output enable time	t _{zL}	3.3	1.0	7.0	10.0	1.0	11.0	
		5.0	1.0	5.5	8.0	1.0	8.5	

3.3

5.0

3.3

5.0

haracteristics HD74AC240 AC

1. Voltage Range 3.3 is 3.3 V \pm 0.3 V Note:

Output disable time

Output disable time

Voltage Range 5.0 is 5.0 V \pm 0.5 V

 \mathbf{t}_{HZ}

 \mathbf{t}_{LZ}

AC Characteristics: HD74ACT240

			Ta = +25°C C _∟ = 50 pF			Ta = –4 C _⊾ = 50		
ltem	Symbol	V _{cc} (V)* ¹	Min	Тур	Max	Min	Max	Unit
Propagation delay Data to output	t _{PLH}	5.0	1.0	6.0	8.5	1.0	9.5	ns
Propagation delay Data to output	t _{PHL}	5.0	1.0	5.5	7.5	1.0	8.5	ns
Output enable time	t _{zH}	5.0	1.0	7.0	8.5	1.0	9.5	ns
Output enable time	t _{zL}	5.0	1.0	7.0	9.5	1.0	10.5	ns
Output disable time	t _{HZ}	5.0	1.0	8.0	9.5	1.0	10.5	ns
Output disable time	t _{LZ}	5.0	1.0	6.5	10.0	1.0	10.5	ns

7.0

6.5

7.5

6.5

1.0

1.0

1.0

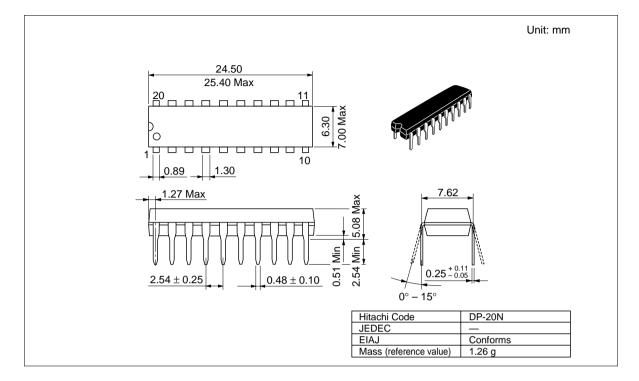
1.0

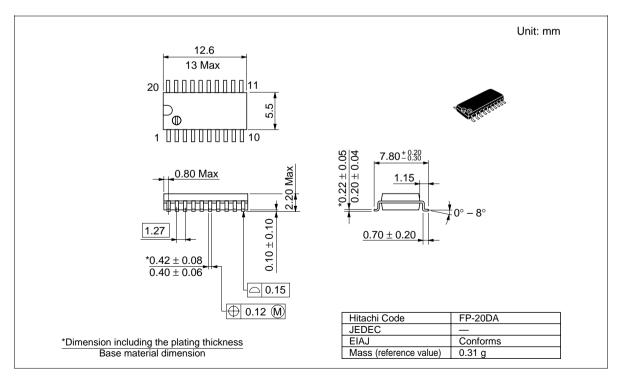
1. Voltage Range 5.0 is 5.0 V \pm 0.5 V Note:

Capacitance

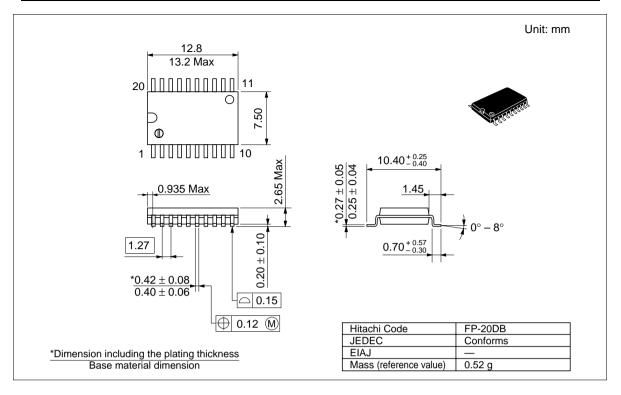
Item	Symbol	Тур	Unit	Condition
Input capacitance	CIN	4.5	pF	$V_{cc} = 5.5 V$
Power dissipation capacitance	C _{PD}	45.0	pF	$V_{cc} = 5.0 V$

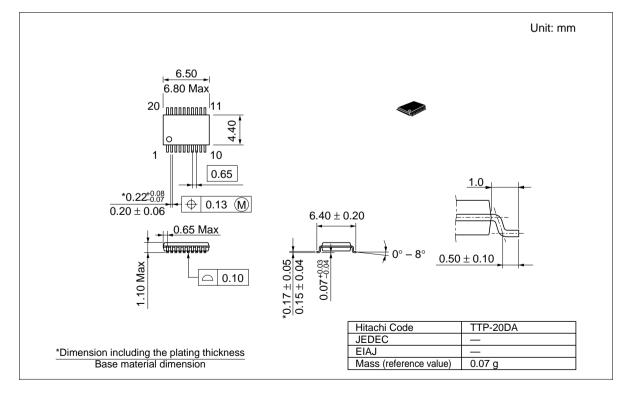
Package Dimensions





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